

### **General Description**

This product family offers state of the art performance. It is designed for high frequency applications where high efficiency and high reliability are required.

### Features

- Low conduction loss due to low V  $_{\rm F}$
- Extremely low switching loss by tiny Q C
- Highly rugged due to better surge current
- Industrial standard quality and reliability

## **Applications**

- UPS
- Power Inverter
- High performance SMPS
- Power factor correction



Part Number	Package	Marking
FFSH2065A	TO-247-2L	F2065SHVU

## **Maximum Ratings**

Symbol	Parameter	Value	Unit	Test Conditions
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	650	V	
V <sub>RSM</sub>	Surge Peak Reverse Voltage	650	V	
V <sub>R</sub>	DC Peak Reverse Voltage	650	V	
I <sub>F</sub>	Continuous Forward Current	26	А	T <sub>c</sub> =135°C
I <sub>FRM</sub>	Repetitive Peak Forward Surge Current	102 63	А	$T_c$ =25°C, t <sub>p</sub> =10 ms, Half Sine Wave, D=1 T_c=110°C, t <sub>p</sub> =10 ms, Half Sine Wave, D=1
I <sub>FSM</sub>	Non-Repetitive Peak Forward Surge Current	150 120	А	$T_c$ =25°C, t <sub>p</sub> =10ms, Half Sine Wave, D=1 T <sub>c</sub> =110°C, t <sub>p</sub> =10 ms, Half Sine Wave, D=1
P <sub>tot</sub>	Power Dissipation	150 65	w	T <sub>c</sub> =25°C T <sub>c</sub> =110°C
∫i²dt	i <sup>2</sup> dt value	112 72	A <sup>2</sup> s	$T_{c} = 25^{\circ}C, t_{p}=10ms, Half Sine Pulse$ $T_{c} = 110^{\circ}C, t_{p}=10ms, Half Sine Pulse$
T,	Operating Junction Range	-55 to +175	°C	
T <sub>stg</sub>	Storage Temperature Range	-55 to +150	°C	







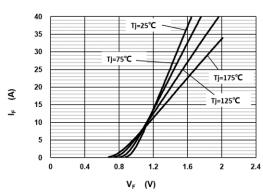
## **Electrical Characteristics**

Parameter	Symbol	Value			Unit	Test Condition
	Symbol	min.	typ.	max.	Onit	Test condition
						I <sub>F</sub> =20A
Forward Voltage	V <sub>F</sub>	-	1.35	1.5	V	T <sub>j</sub> =25°C
		-	1.7	1.8		T <sub>j</sub> =175°C
	I <sub>R</sub>				μΑ	V <sub>R</sub> =650V
Reverse Current		-	2	40		T <sub>j</sub> =25°C
		-	10	100		T <sub>j</sub> =175°C
Total Capacitive Charge	Q <sub>c</sub>			-	nC	V <sub>R</sub> =400V, T <sub>j</sub> =25℃
		-	52			$V_{R} = 400V,  T_{j} = 25^{\circ}C$ $Q_{C} = \int_{0}^{V_{R}} C(V) dV$
Total Capacitance	С					T <sub>j</sub> =25℃, f=1MHz
		-	1018	-	pF	V <sub>R</sub> =0V
		-	104	-		V <sub>R</sub> =200V
		-	89	-		V <sub>R</sub> =400V

## **Thermal Characteristics**

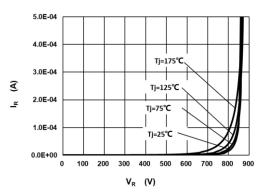
Symbol	Parameter	Тур.	Unit
R <sub>eJC</sub>	Thermal Resistance from Junction to Case	1.00	°C/W

# **Typical Performance**



### Fig 1: Forward Characteristics

#### Fig 2: Reverse Characteristics





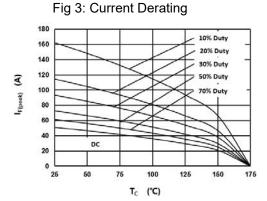
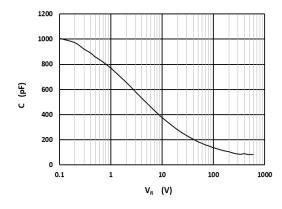
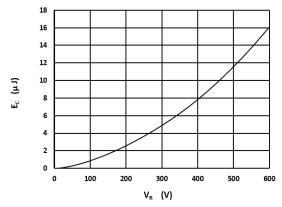


Fig 5: Capacitance vs. Reverse Voltage







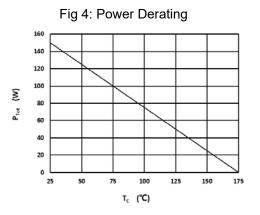
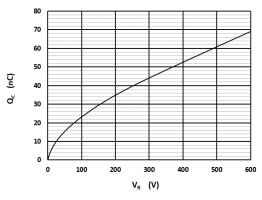
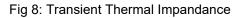
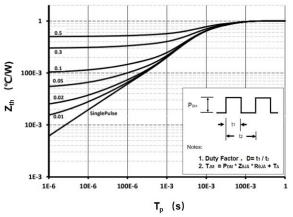


Fig 6: Reverse Charge vs. Reverse Voltage



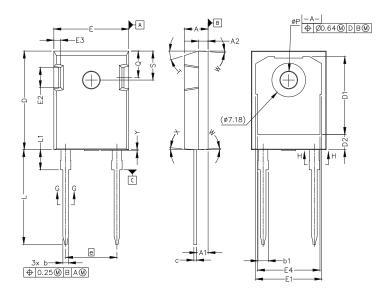






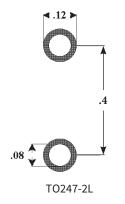
# **Package Dimensions**

Package: TO247-2L All dimensions in mm.

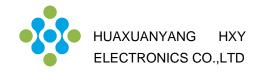


0.01	MILLIM	ETERS	INCHES		
SYM	MIN	MAX	MIN	MAX	
A	4.83	5.21	.190	.205	
Al	2.29	2.54	.090	.100	
A2	1.91	2.16	.075	.085	
b'	1.07	1.28	.042	.050	
b	1.07	1.33	.042	.052	
b1	1.91	2.41	.075	.095	
b2	1.91	2.16	.075	.085	
c'	0.55	0.65	.022	.026	
с	0.55	0.68	.022	.027	
D	20.80	21.10	.819	.831	
D1	16.25	17.35	.640	.683	
D2	2.86	3.16	.112	.124	
Е	15.75	16.13	.620	.635	
E1	13.10	14.15	.516	.557	
E2	3.68	5.10	.145	.201	
E3	1.00	1.90	.039	.075	
E4	12.38	13.43	.487	.529	
e	10.88	BSC	.428 BSC		
L	19.81	20.32	.780	.800	
Ll	4.10	4.40	.161	.173	
ØP	3.51	3.65	.138	.144	
Q	5.49	6.00	.216	.236	
S	6.04	6.30	.238	.248	
Т	17.5° REF.				
W	3.5° REF.				
Х	4° REF.				
Y	0	0.50	0	0.020	

**Recommended Solder Pad Layout** 



all units are in inches



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